## ISL90462

Single Volatile 32-tap XDCP

#### Data Sheet

#### October 7, 2005

### FN8230.3

# Digitally Controlled Potentiometer (XDCP™)

intersil

The Intersil ISL90462 is a digitally controlled potentiometer (XDCP). Configured as a variable resistor, the device consists of a resistor array, wiper switches, a control section, and volatile memory. The wiper position is controlled by a 2-pin Up /Down interface.

The potentiometer is implemented by a resistor array composed of 31 resistive elements and a wiper switching network. Between each element and at either end are tap points accessible to the wiper terminal. The position of the wiper element is controlled by the  $\overline{\text{CS}}$  and  $U/\overline{\text{D}}$  inputs.

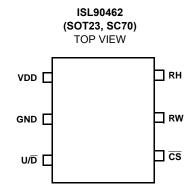
The device can be used in a wide variety of applications including:

- · LCD contrast control
- · Parameter and bias adjustments
- · Industrial and Automotive Control
- Transducer adjustment of pressure, temperature, position, chemical, and optical sensors
- · Laser Diode driver biasing
- · Gain control and offset adjustment

#### Features

- · Volatile Solid-State Potentiometer
- · 2-pin UP/DN Interface
- DCP Terminal Voltage, 2.7V to 5.5V
- Tempco 35ppm/°C Typical
- 32 Wiper Tap Points
- Low Power CMOS
  - Active current, 25µA max.
  - Supply current 0.3µA
- Available  $R_{TOTAL}$  Values =  $10k\Omega$ ,  $50k\Omega$ ,  $100k\Omega$
- Temperature Range -40°C to +85°C
- Packages
  - 6 Ld SC-70, SOT-23
- Pb-Free Plus Anneal Available (RoHS Compliant)

#### Pinout

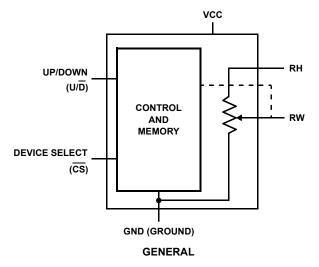


## **Ordering Information**

PART NUMBER	PART MARKING	R <sub>TOTAL</sub> (K)	TEMP RANGE (°C)	PACKAGE (Tape and Reel)	PKG. DWG. #
ISL90462WIE627-TK	AJS	10	-40 to +85	6 Ld SC-70	P6.049
ISL90462WIE627Z-TK (See Note)	DEK		-40 to +85	6 Ld SC-70 (Pb-free)	P6.049
ISL90462WIH627-TK	AKB		-40 to +85	6 Ld SOT-23	P6.064
ISL90462WIH627Z-TK (See Note)	DEL		-40 to +85	6 Ld SOT-23 (Pb-free)	P6.064
ISL90462UIE627-TK	AJU	50	-40 to +85	6 Ld SC-70	P6.049
ISL90462UIE627Z-TK (See Note)	DEI		-40 to +85	6 Ld SC-70 (Pb-free)	P6.049
ISL90462UIH627-TK	AKD		-40 to +85	6 Ld SOT-23	P6.064
ISL90462UIH627Z-TK (See Note)	DEJ		-40 to +85	6 Ld SOT-23 (Pb-free)	P6.064
ISL90462TIE627-TK	AJT	100	-40 to +85	6 Ld SC-70	P6.049
ISL90462TIE627Z-TK (See Note)	DEG		-40 to +85	6 Ld SC-70 (Pb-free)	P6.049
ISL90462TIH627-TK	AKC		-40 to +85	6 Ld SOT-23	P6.064
ISL90462TIH627Z-TK See Note)	DEH		-40 to +85	6 Ld SOT-23 (Pb-free)	P6.064

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020

## Block Diagram



## Pin Descriptions

6-PIN	SYMBOL	DESCRIPTION
1	VDD	Supply voltage
2	GND	Ground/Low terminal
3	U/D	Up - Down
4	CS	Chip select
5	RW	Wiper terminal
6	RH	High terminal

#### **Absolute Maximum Ratings**

Storage Temperature65°C to +150°C
Voltage on CS, U/D and VCC With Respect to GND1V to +7V
Lead Temperature (soldering 10s)
I <sub>W</sub> (10s)
Power Rating

#### **Recommended Operating Conditions**

Temperature Range (Industrial)	40°C to 85°C
V <sub>CC</sub>	2.7V to 5.5V

CAUTION: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP (Note 4)	МАХ	UNIT
R <sub>TOT</sub>	End to end resistance	W version	8	10	12	kΩ
		U version	40	50	60	kΩ
		T version	80	100	120	kΩ
V <sub>R</sub>	RH, R <sub>L</sub> terminal voltages		0		V <sub>CC</sub>	V
	Noise	Ref: 1kHz		-120		dBV
RW	Wiper Resistance			600		Ω
IW	Wiper Current				0.6	mA
	Resolution		1		32	Taps
	Absolute linearity (Note 1)	R <sub>H(n)(actual)</sub> - R <sub>H(n)(expected)</sub>			±1	MI (Note 3)
	Relative linearity (Note 2)	R <sub>H(n+1)</sub> - [R <sub>H(n)</sub> + <sub>MI</sub> ]			±0.5	MI (Note 3)
	R <sub>TOTAL</sub> temperature coefficient			±35		ppm/°C
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer capacitances	See Equivalent Circuit		10/10/25		pF

NOTES:

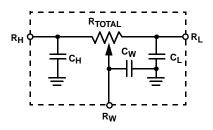
1. Absolute linearity is utilized to determine actual wiper voltage versus expected voltage =  $(R_{H(n)}(actual)-R_{H(n)}(expected)) = \pm 1$  MI Maximum. n = 1 .. 29 only

2. Relative linearity is a measure of the error in step size between taps =  $R_{H(n+1)}$ -[ $R_{H(n)}$  + MI] = ±0.5 MI, n = 1 ... 29 only.

3. 1 MI = Minimum Increment =  $R_{TOT}/31$ .

4. Typical values are for  $T_A = 25^{\circ}C$  and nominal supply voltage.

## Equivalent Circuit



SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP (NOTE 4)	МАХ	UNIT
Icc	V <sub>CC</sub> active current (Increment)	$\overline{\text{CS}}$ = 0V, U/ $\overline{\text{D}}$ = f <sub>clock</sub> = 1MHz and V <sub>CC</sub> = 3V			25	μA
I <sub>SB</sub>	Standby supply current	$\overline{CS} = V_{CC}, U/\overline{D} = GND \text{ or } V_{CC} = 3V$		0.3	1	μA
ILI	CS input leakage current	$V_{IN}$ = GND to $V_{CC}$			±1	μA
V <sub>IH</sub>	CS, U/D input HIGH voltage		V <sub>CC</sub> x 0.7			V
VIL	CS, U/D input LOW voltage				V <sub>CC</sub> x 0.3	V
C <sub>IN</sub>	CS, U/D input capacitance	$V_{CC}$ = 3V, $V_{IN}$ = GND, $T_A$ = 25°C, f = 1MHz		10		pF

### DC Electrical Specifications Over recommended operating conditions unless otherwise specified.

**Timing Specifications** 

Over recommended operating conditions unless otherwise specified

SYMBOL	PARAMETER	MIN	TYP (Note 4)	MAX	UNIT
t <sub>CU</sub>	$U/\overline{D}$ to $\overline{CS}$ setup	25			ns
t <sub>CI</sub>	CS to U/D setup	50			ns
t <sub>IC</sub>	$\overline{CS}$ to U/ $\overline{D}$ hold	25			ns
t <sub>IL</sub>	U/D LOW period	300			ns
t <sub>IH</sub>	U/D HIGH period	300			ns
ftoggle	Up/Down toggle Rate		1		MHz
t <sub>SETTLE</sub>	Output settling time		1		μs

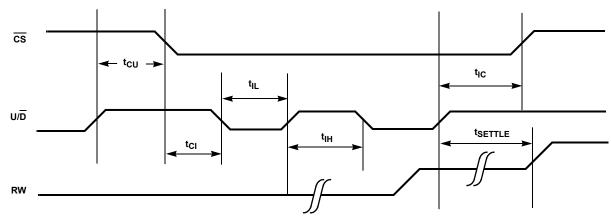


FIGURE 1. SERIAL INTERFACE TIMING DIAGRAM, INCREMENT

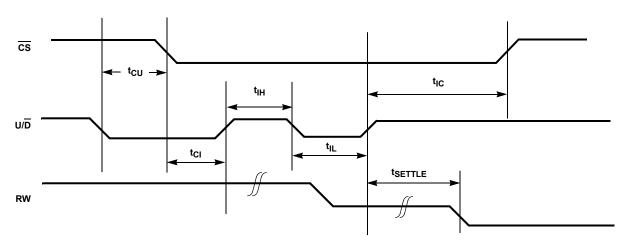


FIGURE 2. SERIAL INTERFACE TIMING DIAGRAM DECREMENT

## **Pin Descriptions**

#### RH and RW

The ISL90462 contains a digital potentiometer with one terminal tied to the ground pin (GND) of the device. The RH pin is the other potentiometer terminal, and the RW pin is the wiper terminal. The position of the wiper is controlled by the  $\overline{\text{CS}}$ - and U/D- inputs, with a movement "up" connecting the wiper closer to the RH pin, and movement "down" connection the wiper closer to the GND pin.

## Up/Down (U/D)

The  $U/\overline{D}$  input controls the direction of the wiper movement and whether the counter is incremented or decremented.

## Chip Select (CS)

The device is selected when the  $\overline{CS}$  input is LOW. The current counter value is stored in volatile memory when  $\overline{CS}$  is returned HIGH. When  $\overline{CS}$  is high, the device is placed in low power standby mode.

## Principles of Operation

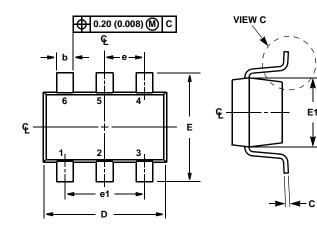
There are two sections of the ISL90462: the input control, counter and decode section; and the resistor array. The input control section operates just like an up/down counter. The output of this counter is decoded to turn on a single electronic switch connecting a point on the resistor array to the wiper output. The resistor array is comprised of 31 individual resistors connected in series. At either end of the array and between each resistor is an electronic switch that transfers the connection at that point to the wiper. The RH and RW terminals are uncommitted, and can for a variable voltage divider if RH is connected to a voltage source.

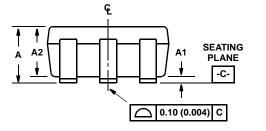
The direction of the wiper movement is defined when the device is selected. If during  $\overline{CS}$  transition from High to Low the U/ $\overline{D}$  input is LOW, the wiper will move down on each rising edge of U/ $\overline{D}$  toggling. Similarly, the wiper will move up on each rising edge of U/ $\overline{D}$  toggling if, during  $\overline{CS}$  transition from High to Low, the U/ $\overline{D}$  input is High.

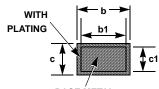
The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. That is, the counter does not wrap around when clocked to either extreme.

If the wiper is moved several positions, multiple taps are connected to the wiper for  $t_{\text{SETTLE}}$  (U/D to RW change). The 2-terminal resistance value for the device can temporarily change by a significant amount if the wiper is moved several positions.

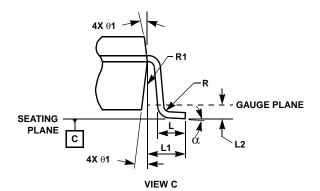
## Small Outline Transistor Plastic Packages (SOT23-6)











P6.	0	6	4
-----	---	---	---

6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

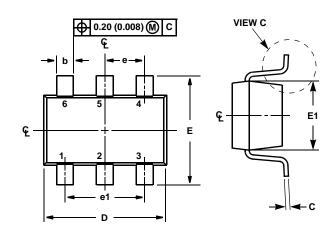
	INC	HES	MILLIN		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.036	0.057	0.90	1.45	-
A1	0.000	0.0059	0.00	0.15	-
A2	0.036	0.051	0.90	1.30	-
b	0.012	0.020	0.30	0.50	-
b1	0.012	0.018	0.30	0.45	
С	0.003	0.009	0.08	0.22	6
c1	0.003	0.008	0.08	0.20	6
D	0.111	0.118	2.80	3.00	3
E	0.103	0.118	2.60	3.00	-
E1	0.060	0.068	1.50	1.75	3
е	0.037	0.0374 Ref		5 Ref	-
e1	0.074	0.0748 Ref		0 Ref	-
L	0.014	0.022	0.35	0.55	4
L1	0.024	Ref.	0.60	) Ref.	
L2	0.010	) Ref.	0.25	5 Ref.	
Ν	6	6	6		5
R	0.004	-	0.10	-	
R1	0.004	0.010	0.10	0.25	
α	0 <sup>0</sup>	8 <sup>0</sup>	0 <sup>0</sup>	8 <sup>0</sup>	-
				·	Rev. 3 9/03

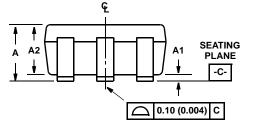
#### NOTES:

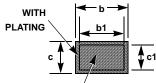
1. Dimensioning and tolerance per ASME Y14.5M-1994.

- 2. Package conforms to EIAJ SC-74 and JEDEC MO178AB.
- 3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
- 4. Footlength L measured at reference to gauge plane.
- 5. "N" is the number of terminal positions.
- 6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

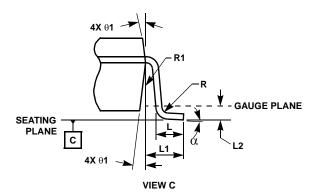
## Small Outline Transistor Plastic Packages (SC70-6)











6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

	INC	HES	MILLIN		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.031	0.043	0.80	1.10	-
A1	0.000	0.004	0.00	0.10	-
A2	0.031	0.039	0.00	1.00	-
b	0.006	0.012	0.15	0.30	-
b1	0.006	0.010	0.15	0.25	
С	0.003	0.009	0.08	0.22	6
c1	0.003	0.009	0.08	0.20	6
D	0.073	0.085	1.85	2.15	3
E	0.071	0.094	1.80	2.40	-
E1	0.045	0.053	1.15	1.35	3
е	0.025	0.0256 Ref		5 Ref	-
e1	0.051	2 Ref	1.30	) Ref	-
L	0.010	0.018	0.26	0.46	4
L1	0.017	7 Ref.	0.42	0 Ref.	
L2	0.006	BSC	0.15	BSC	
Ν	6	6	6		5
R	0.004	-	0.10	-	
R1	0.004	0.010	0.15	0.25	
α	0 <sup>0</sup>	8 <sup>0</sup>	0 <sup>0</sup>	8 <sup>0</sup>	-
4				•	Rev. 2 9/03

#### NOTES:

1. Dimensioning and tolerance per ASME Y14.5M-1994.

- 2. Package conforms to EIAJ SC70 and JEDEC MO203AB.
- 3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
- 4. Footlength L measured at reference to gauge plane.
- 5. "N" is the number of terminal positions.
- 6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

All Intersil U.S. products are manufactured, assembled and tested utilizing ISO9000 quality systems. Intersil Corporation's quality certifications can be viewed at www.intersil.com/design/quality

Intersil products are sold by description only. Intersil Corporation reserves the right to make changes in circuit design, software and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

